AMENDMENTS TO THE CLAIMS

1. (Withdrawn) A substrate processing method, comprising:

carrying out a cleaning treatment and a catalyst-imparting treatment of a surface of a substrate as pre-plating treatments; and then

electroless plating a metal film on the catalyst-imparted surface of the substrate,

wherein the cleaning treatment is carried out in a wider area of the surface of the substrate than that area to which a catalyst is imparted by the catalyst-imparting treatment.

- 2. (Withdrawn) The substrate processing method according to claim 1, wherein the cleaning treatment as a pre-plating treatment comprises pre-cleaning prior to the catalyst-imparting treatment and cleaning after the catalyst-imparting treatment.
- 3. (Withdrawn) The substrate processing method according to claim 1, wherein the area of the surface of the substrate to which a catalyst is imparted by the catalyst-imparting treatment is the same as that area for which uniform plating is necessary.
- 4. (Withdrawn) The substrate processing method according to claim 3, wherein the cleaning treatment as a pre-plating treatment comprises pre-cleaning prior to the catalyst-imparting treatment and cleaning after the catalyst-imparting treatment.
 - 5. (Withdrawn) A substrate processing apparatus, comprising: a cleaning treatment unit for carrying out a cleaning treatment of a substrate; and

Attorney Docket No. 2003_1659A Serial No. 10/712,373

February 25, 2008

a catalyst-imparting treatment unit for carrying out a catalyst-imparting treatment of the

substrate,

wherein said respective treatment is carried out as a pre-plating treatment by allowing the

surface of the substrate to be in contact with a respective pre-plating treatment liquid while sealing a

peripheral portion of the surface of the substrate with a seal ring, the cleaning treatment unit being

designed to carry out the cleaning treatment in a wider area of the surface of the substrate than that

area to which a catalyst is imparted in the catalyst-imparting treatment unit.

6. (Withdrawn) The substrate processing apparatus according to claim 5, wherein the

cleaning treatment unit and the catalyst-imparting treatment unit have the same construction except

that the seal rings have different opening areas.

7. (Withdrawn) The substrate processing apparatus according to claim 5, wherein the area

of the surface of the substrate to which a catalyst is imparted in the catalyst-imparting treatment unit

is the same as that area for which uniform plating is necessary.

8. (Withdrawn) The substrate processing apparatus according to claim 7, wherein the

cleaning treatment unit and the catalyst-imparting treatment unit have the same construction except

that the seal rings have different opening areas.

9. (Currently amended) A substrate processing unit, comprising that includes:

a substrate receiving ring to which a seal ring is mounted;

a vertically movable substrate holder having a substrate fixing ring for movable so as to

4

Attorney Docket No. 2003_1659A Serial No. 10/712,373 February 25, 2008

holding hold a substrate by nipping a peripheral portion of the substrate between the substrate fixing

ring and the seal ring to seal the peripheral portion of the substrate during processing of the substrate;

and

a temporary retaining section, that is mounted to the substrate receiving ring and positioned

around the seal ring, for to temporarily retaining the substrate thereon while forming a space between

the substrate and the seal ring.

10. (Currently amended) The substrate processing unit according to claim 9, wherein the

substrate processing unit eomprises-is a pre-plating treatment unit for carrying out a pre-plating

treatment of the substrate prior to plating.

11. (Original) The substrate processing unit according to claim 10, wherein the pre-plating

treatment unit is a catalyst-imparting treatment unit for imparting a catalyst to the surface of the

substrate.

12. (Original) The substrate processing unit according to claim 10, wherein the pre-plating

treatment unit is a cleaning treatment unit for cleaning the surface of the substrate.

13. (Original) The substrate processing unit according to claim 9, wherein the substrate

receiving ring and the substrate fixing ring hold the substrate with its front surface facing downward.

14. (Original) The substrate processing unit according to claim 13, wherein the temporary

retaining section is comprised of a plurality of temporary retaining pins which are biased upwardly

5

Attorney Docket No. 2003_1659A Serial No. 10/712,373

February 25, 2008

by an elastic member, and which lower integrally with the substrate holder against the elastic force of

the elastic member as the substrate holder lowers, and return to the original position as the substrate

holder rises.

15. (Currently amended) The substrate processing unit according to claim 14, wherein the

substrate processing unit eomprises is a pre-plating treatment unit for carrying out a pre-plating

treatment of the substrate prior to plating.

16. (Original) The substrate processing unit according to claim 15, wherein the pre-plating

treatment unit is a catalyst-imparting treatment unit for imparting a catalyst to the surface of the

substrate.

17. (Original) The substrate processing unit according to claim 15, wherein the pre-plating

treatment unit is a cleaning treatment unit for cleaning the surface of the substrate.

18. (Original) The substrate processing unit according to claim 14, wherein the head portion

of each temporary retaining pin has a forward tapered surface for guiding the circumferential end

surface of the substrate and positioning the substrate.

19. (Currently amended) The substrate processing unit according to claim 18, wherein the

substrate processing unit comprises is a pre-plating treatment unit for carrying out a pre-plating

treatment of the substrate prior to plating.

6

Attorney Docket No. 2003_1659A Serial No. 10/712,373 February 25, 2008

- 20. (Original) The substrate processing unit according to claim 19, wherein the pre-plating treatment unit is a catalyst-imparting treatment unit for imparting a catalyst to the surface of the substrate.
- 21. (Original) The substrate processing unit according to claim 19, wherein the pre-plating treatment unit is a cleaning treatment unit for cleaning the surface of the substrate.